

# **BAT54W series**

# Schottky barrier diodes

Rev. 3 — 20 November 2012

Product data sheet

## 1. Product profile

#### 1.1 General description

Planar Schottky barrier diodes with an integrated guard ring for stress protection, encapsulated in a very small SOT323 (SC-70) Surface-Mounted Device (SMD) plastic package.

#### 1.2 Features and benefits

- Low forward voltage
- Low capacitance
- AEC-Q101 qualified

## 1.3 Applications

- Ultra high-speed switching
- Line termination

- Voltage clamping
- Reverse polarity protection

#### 1.4 Quick reference data

Table 1. Quick reference data  $T_{amb} = 25 \, ^{\circ}\text{C}$  unless otherwise specified.

| unio -         | <u> </u>        |                        |              |     |     |      |
|----------------|-----------------|------------------------|--------------|-----|-----|------|
| Symbol         | Parameter       | Conditions             | Min          | Тур | Max | Unit |
| Per diode      |                 |                        |              |     |     |      |
| $V_R$          | reverse voltage |                        | -            | -   | 30  | V    |
| $V_{F}$        | forward voltage | $I_F = 100 \text{ mA}$ | <u>[1]</u> _ | -   | 800 | mV   |
| I <sub>R</sub> | reverse current | $V_{R} = 25 \text{ V}$ | <u>[1]</u> _ | -   | 2   | μΑ   |

<sup>[1]</sup> Pulse test:  $t_p \le 300~\mu s;~\delta \le 0.02.$ 

# 2. Pinning information

Table 2. Pinning

Pin Description Simplified outline Graphic symbol

BAT54W

1 anode
2 not connected
3 cathode



 Table 2.
 Pinning ...continued

| Pin     | Description                           | Simplified outline | Graphic symbol |
|---------|---------------------------------------|--------------------|----------------|
| BAT54AW |                                       |                    |                |
| 1       | cathode (diode 1)                     |                    |                |
| 2       | cathode (diode 2)                     | 3                  | 3              |
| 3       | common anode                          | 1 2                | 1              |
| BAT54CW |                                       |                    |                |
| 1       | anode (diode 1)                       |                    | 0              |
| 2       | anode (diode 2)                       | 3                  | 3              |
| 3       | common cathode                        | 1 2                | 1 2 2          |
| BAT54SW |                                       |                    |                |
| 1       | anode (diode 1)                       |                    | _              |
| 2       | cathode (diode 2)                     | 3                  | 3              |
| 3       | cathode (diode 1),<br>anode (diode 2) | 1 2                | 1 2 006aaa437  |

# 3. Ordering information

Table 3. Ordering information

| Type number   | Package |  |         |
|---------------|---------|--|---------|
|               | Name    | Description                              | Version |
| BAT54W series | SC-70   | plastic surface-mounted package; 3 leads | SOT323  |

# 4. Marking

Table 4. Marking codes

| Type number | Marking code <sup>[1]</sup> |
|-------------|-----------------------------|
| BAT54W      | L4*                         |
| BAT54AW     | 42*                         |
| BAT54CW     | 43*                         |
| BAT54SW     | 44*                         |

[1] \* = placeholder for manufacturing site code.

## 5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol           | Parameter                           | Conditions                               | Min          | Max  | Unit |
|------------------|-------------------------------------|--|--------------|------|------|
| Per diode        |                                     |  |              |      |      |
| V <sub>R</sub>   | reverse voltage                     |  | -            | 30   | V    |
| I <sub>F</sub>   | forward current                     |  | -            | 200  | mA   |
| I <sub>FRM</sub> | repetitive peak forward current     | $t_p \leq 1 \text{ s; } \delta \leq 0.5$ |              | 300  | mA   |
| I <sub>FSM</sub> | non-repetitive peak forward current | square wave;<br>t <sub>p</sub> < 10 ms   | <u>[1]</u> _ | 600  | mA   |
| Per device;      | one diode loaded                    |  |              |      |      |
| P <sub>tot</sub> | total power dissipation             | $T_{amb} \le 25  ^{\circ}C$              | [2]          | 200  | mW   |
| Tj               | junction temperature                |  | -            | 150  | °C   |
| T <sub>amb</sub> | ambient temperature                 |  | -55          | +150 | °C   |
| T <sub>stg</sub> | storage temperature                 |  | -65          | +150 | °C   |

<sup>[1]</sup>  $T_j = 25$  °C before surge.

## 6. Thermal characteristics

Table 6. Thermal characteristics

| Symbol        | Parameter                                   | Conditions  | Min   | Тур | Max | Unit |
|---------------|---|-------------|-------|-----|-----|------|
| Per device;   | one diode loaded                            |             |       |     |     |      |
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | in free air | [1] - | -   | 625 | K/W  |

<sup>[1]</sup> Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

<sup>[2]</sup> Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

### 7. Characteristics

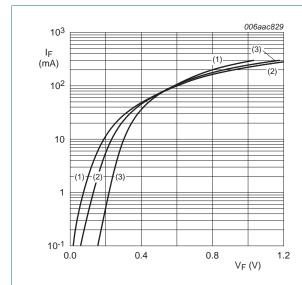
Table 7. Characteristics

 $T_{amb} = 25$  °C unless otherwise specified.

| Symbol          | Parameter              | Conditions              | Min          | Тур | Max | Unit |
|-----------------|------------------------|-------------------------|--------------|-----|-----|------|
| Per diod        | е                      |                         |              |     |     |      |
| $V_{F}$         | forward voltage        |                         | <u>[1]</u>   |     |     |      |
|                 |                        | $I_F = 0.1 \text{ mA}$  | -            | -   | 240 | mV   |
|                 |                        | $I_F = 1 \text{ mA}$    | -            | -   | 320 | mV   |
|                 |                        | I <sub>F</sub> = 10 mA  | -            | -   | 400 | mV   |
|                 | I <sub>F</sub> = 30 mA | -                       | -            | 500 | mV  |      |
|                 |                        | I <sub>F</sub> = 100 mA | -            | -   | 800 | mV   |
| $I_R$           | reverse current        | V <sub>R</sub> = 25 V   | <u>[1]</u> - | -   | 2   | μΑ   |
| $C_{d}$         | diode capacitance      | $f = 1 MHz; V_R = 1 V$  | -            | -   | 10  | pF   |
| t <sub>rr</sub> | reverse recovery time  |                         | [2] _        | -   | 5   | ns   |

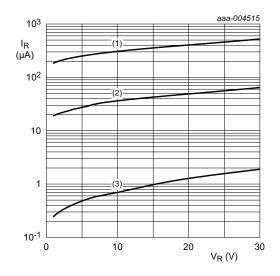
<sup>[1]</sup> Pulse test:  $t_p \le 300~\mu s;~\delta \le 0.02.$ 

<sup>[2]</sup> When switched from  $I_F$  = 10 mA to  $I_R$  = 10 mA;  $R_L$  = 100  $\Omega$ ; measured at  $I_R$  = 1 mA.



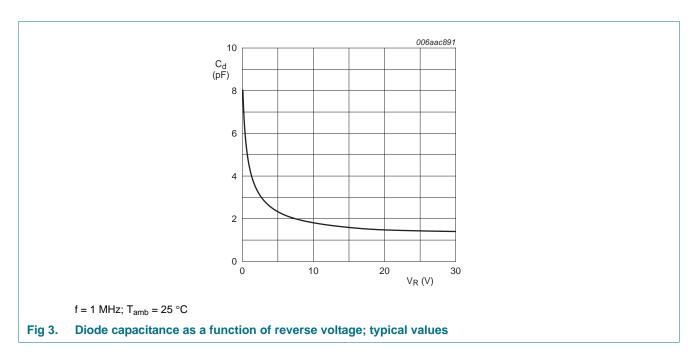
- (1)  $T_{amb} = 125 \, ^{\circ}C$
- (2)  $T_{amb} = 85 \, ^{\circ}C$
- (3)  $T_{amb} = 25 \, ^{\circ}C$

Fig 1. Forward current as a function of forward voltage; typical values

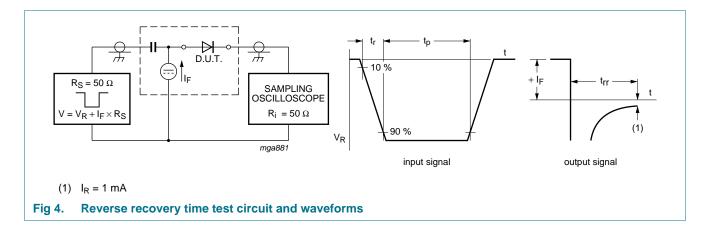


- (1)  $T_{amb} = 125 \, ^{\circ}C$
- (2)  $T_{amb} = 85 \, ^{\circ}C$
- (3)  $T_{amb} = 25 \, ^{\circ}C$

Fig 2. Reverse current as a function of reverse voltage; typical values



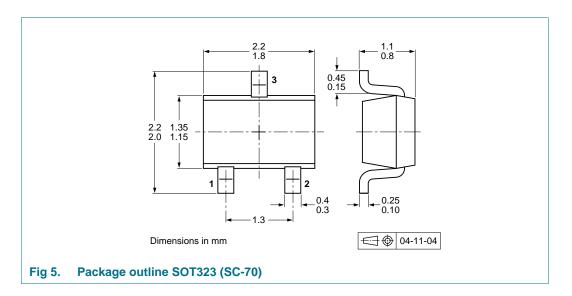
#### 8. Test information



## 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

# 9. Package outline



# 10. Packing information

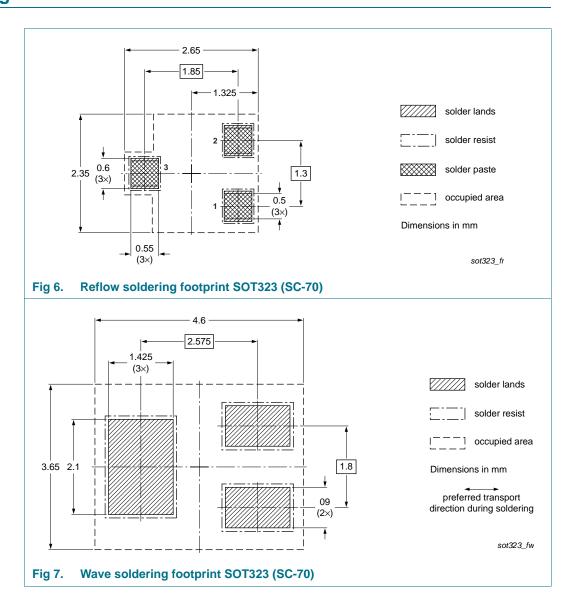
Table 8. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

| Type number   | Package | <b>Description</b> Packing     |      | quantity |  |
|---------------|---------|--------------------------------|------|----------|--|
|               |         |                                | 3000 | 10000    |  |
| BAT54W series | SOT323  | 4 mm pitch, 8 mm tape and reel | -115 | -135     |  |

<sup>[1]</sup> For further information and the availability of packing methods, see Section 14.

# 11. Soldering



# 12. Revision history

#### Table 9. Revision history

| Document ID    | Release date  | Data sheet status            | Change notice | Supersedes |  |  |
|----------------|---|------------------------------|---------------|------------|--|--|
| BAT54W_SER v.3 | 20121120  | Product data sheet           | -             | BAT54W v.2 |  |  |
| Modifications: | <ul> <li>The format of this document has been redesigned to comply with the new identity<br/>guidelines of NXP Semiconductors.</li> </ul> |                              |               |            |  |  |
|                | <ul> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>  |                              |               |            |  |  |
|                | Section 1: updated  |                              |               |            |  |  |
|                | • Section 4: updated  |                              |               |            |  |  |
|                | <ul> <li><u>Table 5</u>: updated ambient temperature T<sub>amb</sub> maximum value to 150 °C</li> </ul>                                   |                              |               |            |  |  |
|                | • Figure 1 to 4: updated  |                              |               |            |  |  |
|                | Section 8 "Test information": added   |                              |               |            |  |  |
|                | • Figure 5: replaced by minimized package outline drawing   |                              |               |            |  |  |
|                | Section 10 "Packing information": added   |                              |               |            |  |  |
|                | Section 11 "Soldering": added   |                              |               |            |  |  |
|                | Section 13  | "Legal information": updated | d             |            |  |  |
| BAT54W v.2     | 19960319  | Product specification        | -             | BAT54W v.1 |  |  |

## 13. Legal information

#### 13.1 Data sheet status

| Document status[1][2]          | Product status[3] | Definition  |
|--------------------------------|-------------------|---|
| Objective [short] data sheet   | Development       | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification     | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production        | This document contains the product specification.                                     |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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BAT54W\_SER

# **BAT54W** series

#### Schottky barrier diodes

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